

MURS140 - MURS160

1.0A SURFACE MOUNT SUPER-FAST RECTIFIER

SPICE MODELS: MURB1610CT MURB1620CT

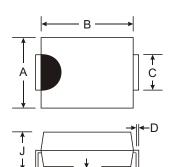
SMB

Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 35A Peak
- Ideally Suited for Automated Assembly
- Plastic Material: UL Flammability Classification Rating 94V-0

Mechanical Data

- Case: Molded Plastic
- Terminals: Solder Plated Terminal -Solderable per MIL-STD-202, Method 208
- Marking: MURS140: U1GB MURS160: U1JB
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.093 grams (approx.)
- Mounting Position: Any
- Ordering Information: See Page 3



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Dim	Min	Max	
Α	3.30	3.94	
В	4.06	4.57	
С	1.96	2.21	
D	0.15	0.31	
Е	5.00	5.59	
G	0.10	0.20	
н	0.76	1.52	
J	2.00	2.62	
All Dimensions in mm			

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	MURS140	MURS160	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	400	600	V
RMS Reverse Voltage	V _{R(RMS)}	283	424	V
$ \begin{array}{c} \mbox{Average Rectified Output Current} & @\ T_T = 150^\circ C \\ & @\ T_T = 125^\circ C \\ \end{array} $	Io	1.0 2.0		А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	35		А
Forward Voltage $ \begin{array}{l} @ \hspace{0.1cm} I_F = 1.0A, \hspace{0.1cm} T_J = 25^{\circ}C \\ @ \hspace{0.1cm} I_F = 1.0A, \hspace{0.1cm} T_J = 150^{\circ}C \end{array} $	V _{FM}	1.25 1.05		V
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	I _{RM}	5.0 150		μA
Reverse Recovery Time (Note 3)		50		ns
Forward Recovery Time (Note 4)		50		ns
Typical Junction Capacitance (Note 2)		45		pF
Typical Thermal Resistance, Junction to Terminal (Note 1)		13		K/W
Operating and Storage Temperature Range		-65 to +175		°C

Notes: 1. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

- 2. Measured at 1.0MHz and applied reverse voltage of 0V DC.
- 3. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See Figure 5.
- 4. Measured with I_F = 1.0A, di/dt = 100A/ μ s, Duty Cycle \leq 2.0%.

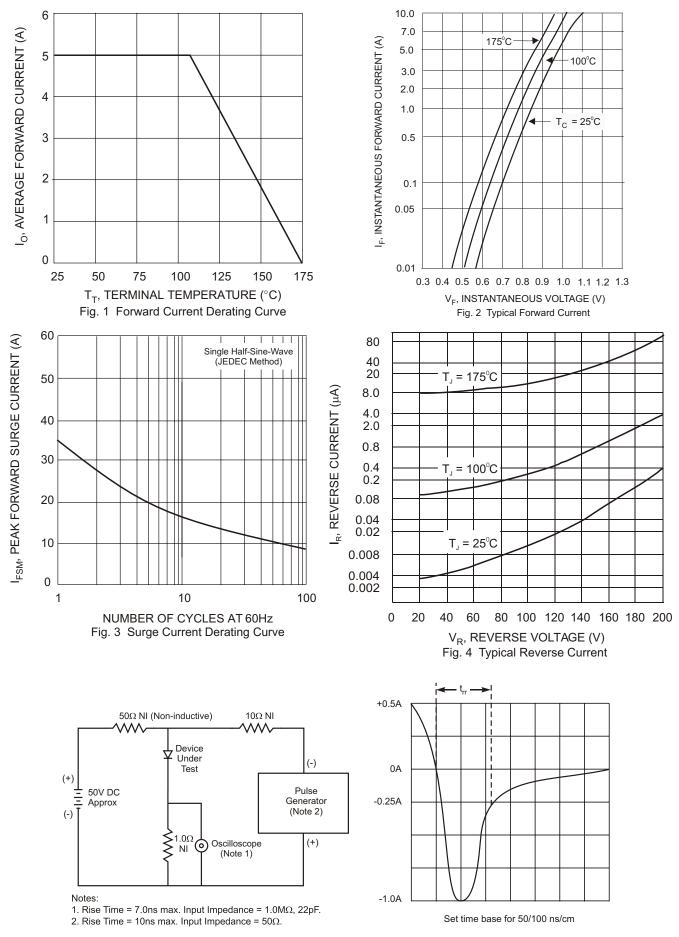


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

Ordering Information (Note 5)

Device	Packaging	Shipping
MURS140-13 MURS160-13	SMB SMB	5000/Tape & Reel

Notes: 5. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXX = Product type marking code (See Page 1))!! = Manufacturers' code marking YWW = Date code marking Y = Last digit of year ex: 2 for 2002 WW = Week code 01 to 52